

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Field device integration (FDI®) –
Part 100: Profiles – Generic Protocols**

**Intégration des appareils de terrain (FDI®) –
Partie 100: Profils – Protocoles Génériques**





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IEC 62769-100 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation. It is an International Standard.

This second edition cancels and replaces the first edition published in 2020. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) added ExtendedDeviceRevision implementing the FDI® Version scheme and the method ScanExtended.

The text of this International Standard is based on the following documents:

Draft	Report on voting
65E/865/CDV	65E/922/RVC

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

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